

Feature

- Chips are electrically insulated from plate
- Package in compliance with international standard. Pressure type, excellent temperature characteristics and power cycling capability
- 350A below modules are forced air cooling, 400A above modules can be selected by air cooling or water cooling

Typical application

- AC, DC motor control, Different kind of rectifying power supply
- Industrial heating and control, Light adjustment, Non-contact switch
- Motor softstarter, Static reactive power compensation
- Welding equipment, Frequency transformer, UPS, Battery charging and discharging

$I_{T(AV)}$	250A
V_{DRM}/V_{RRM}	500-2500V
I_{TSM}	8.5 KA
I^2t	360 $10^3 a^2 s$

SYMBOL	CHARACTERISTIC	TEST CONDITIONS	T_j (°C)	VALUE		UNIT
				Min	Max	
$I_{T(AV)}$	Mean on-state current	180° half sine wave, 50HZ Double side cooled, $T_C=98^\circ C$	125		250	A
$I_{T(RMS)}$	RMS current		125		393	A
V_{DRM} V_{RRM}	Repetitive peak off-state voltage Repetitive peak reverse voltage	$V_{DRM} \& V_{RRM} t_p=10ms$ $V_{DSM} \& V_{RSM}=V_{DRM} \& V_{RRM}+200V$	125	500	2500	V
I_{DRM} I_{RRM}	Repetitive peak current	$V_{DM}=V_{DRM}$ $V_{RM}=V_{RRM}$	125		30	mA
I_{TSM}	Surge on-state current	10ms half sine wave	125		8.5	KA
I^2t	I^2t for fusing coordination	$V_R=0.6V_{RRM}$			360	$A^{2S} * 10$
V_{TO}	Threshold voltage		125		0.8	V
r_T	On-state slope resistance				0.85	$m\Omega$
V_{TM}	Peak on-state voltage	$I_{TM}=750A$	25		1.20	V
dv/dt	Critical rate of rise of-state voltage	$V_{DM}=0.67V_{DRM}$	125		800	V/us
di/dt	Critical rate of rise of on-state current	$V_{DM}=67\%V_{DRM}$ TO 1000A, Gate pulse $t_r \leq 0.5\mu s$ $I_{GM}=1.5A$	125		100	A/us
I_{GT}	Gate trigger current	$V_A=12V, I_A=1A$	25	30	180	mA
V_{GT}	Gate trigger voltage			1.0	2.5	V
I_H	Holding current			20	150	mA
V_{GD}	Npn-trigger gate voltage	$V_{DM}=0.67V_{DRM}$	125		0.2	V
$R_{th(j-c)}$	Thermal impedance node to the shell	180° sine wave, single heat sink			0.120	°C/W
$R_{th(c-h)}$	Thermal impedance (shell to powder)	180° sine wave, single heat sink			0.04	°C/W
V_{iso}	Insulation voltage				2500	V
F_M	Mounting force (M5)				12	N-m
	Mounting force (M6)				6	N-m
T_{stq}	Stored temperature			-40	125	°C
W_t	Weight					g
Outline						

Peak On-state Voltage Vs. Peak On-state Current

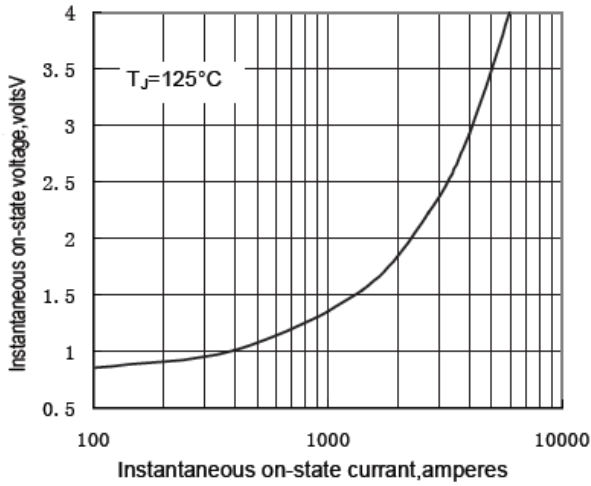


Fig.1

Max. junction To case Thermal Impedance Vs. Time

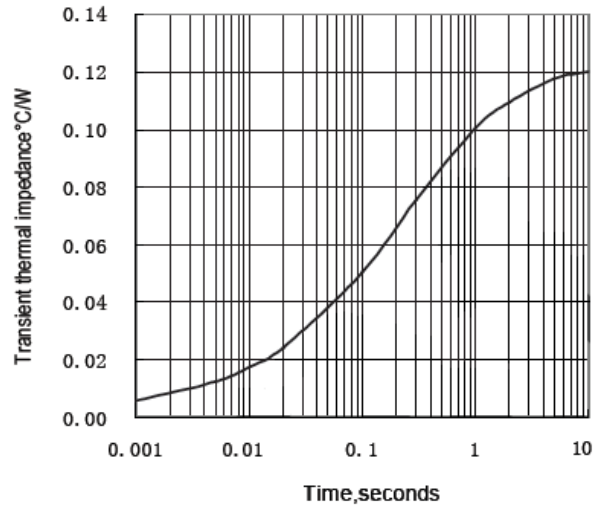


Fig.2

Max. Power Dissipation Vs. Mean On-state Current

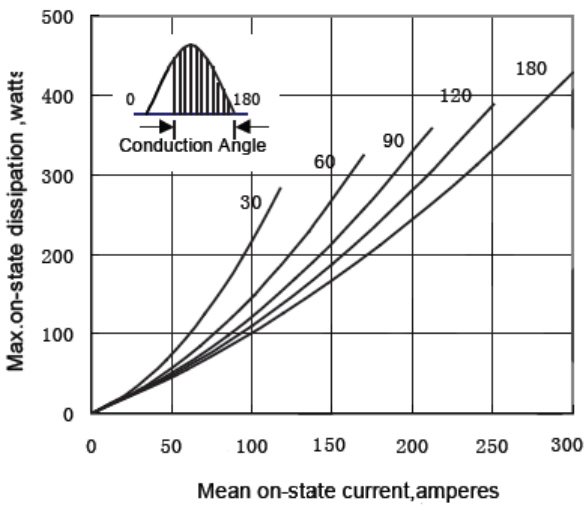


Fig.3

Max. heatsink Temperature Vs. Mean On-state Current

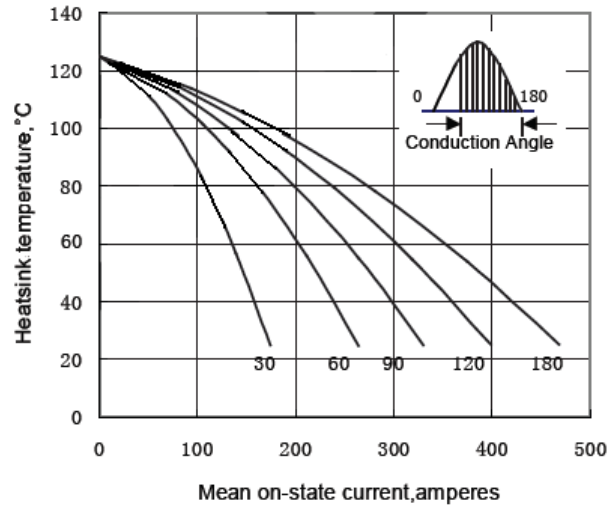


Fig.4

Max. Power Dissipation Vs. Mean On-state Current

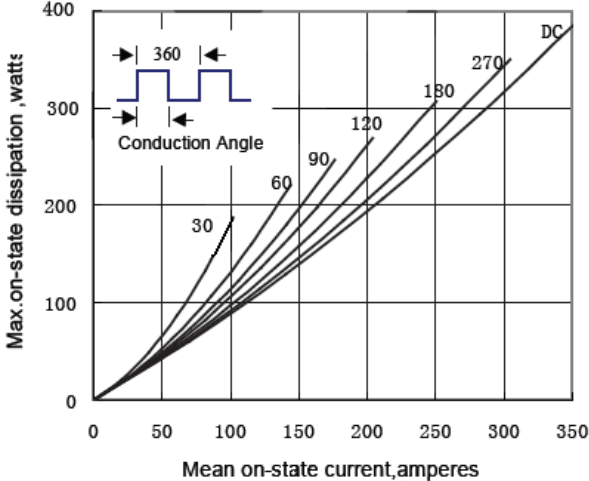


Fig.3

Max. case Temperature Vs. Mean On-state Current

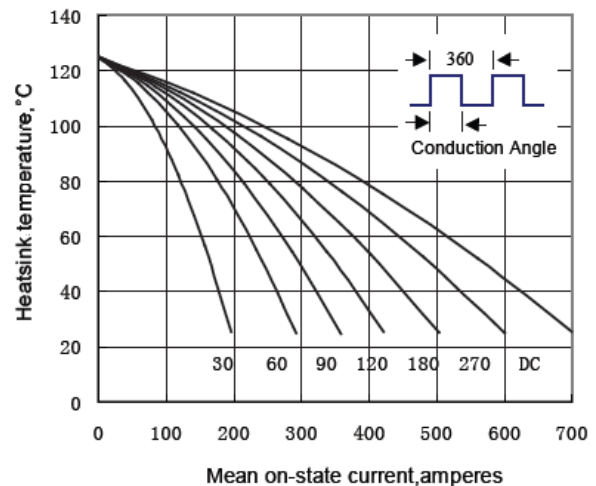


Fig.4

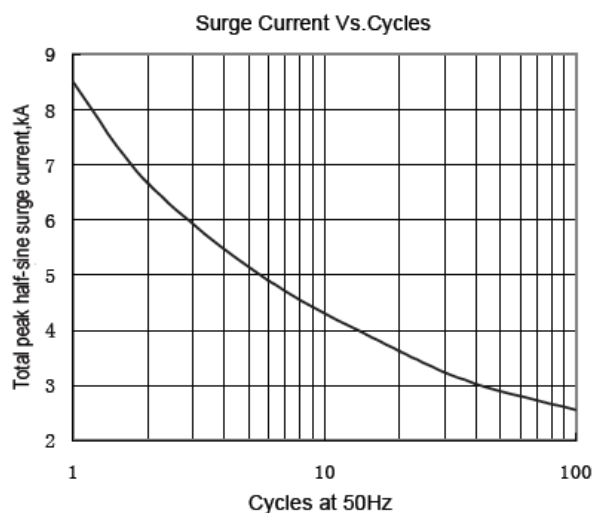


Fig.7

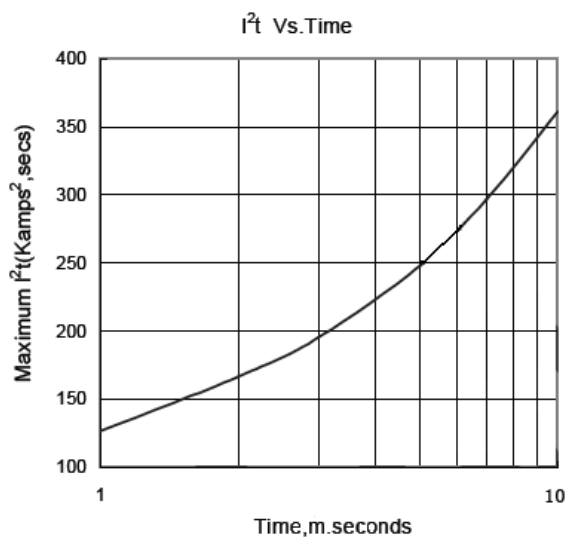


Fig.8

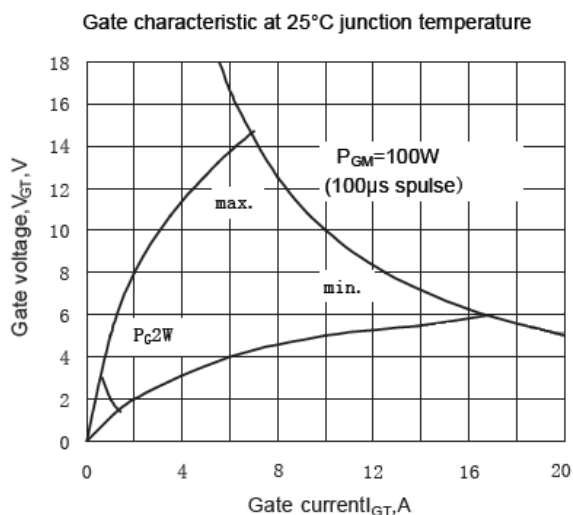


Fig.9

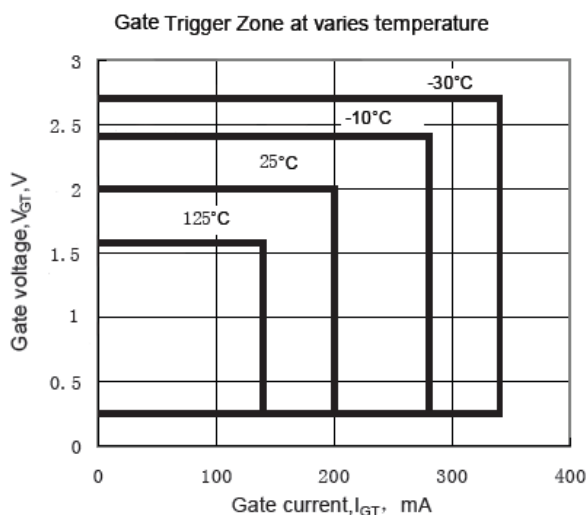
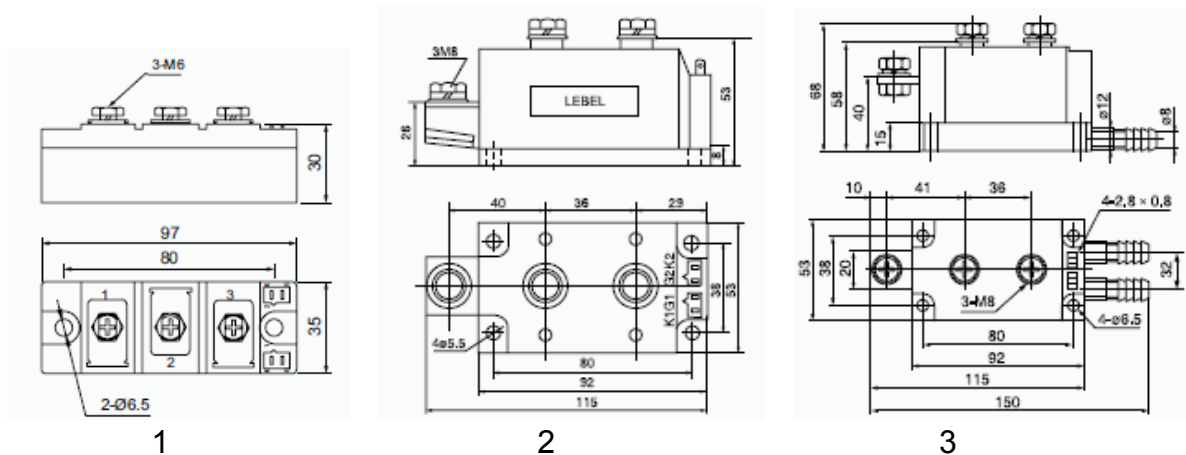
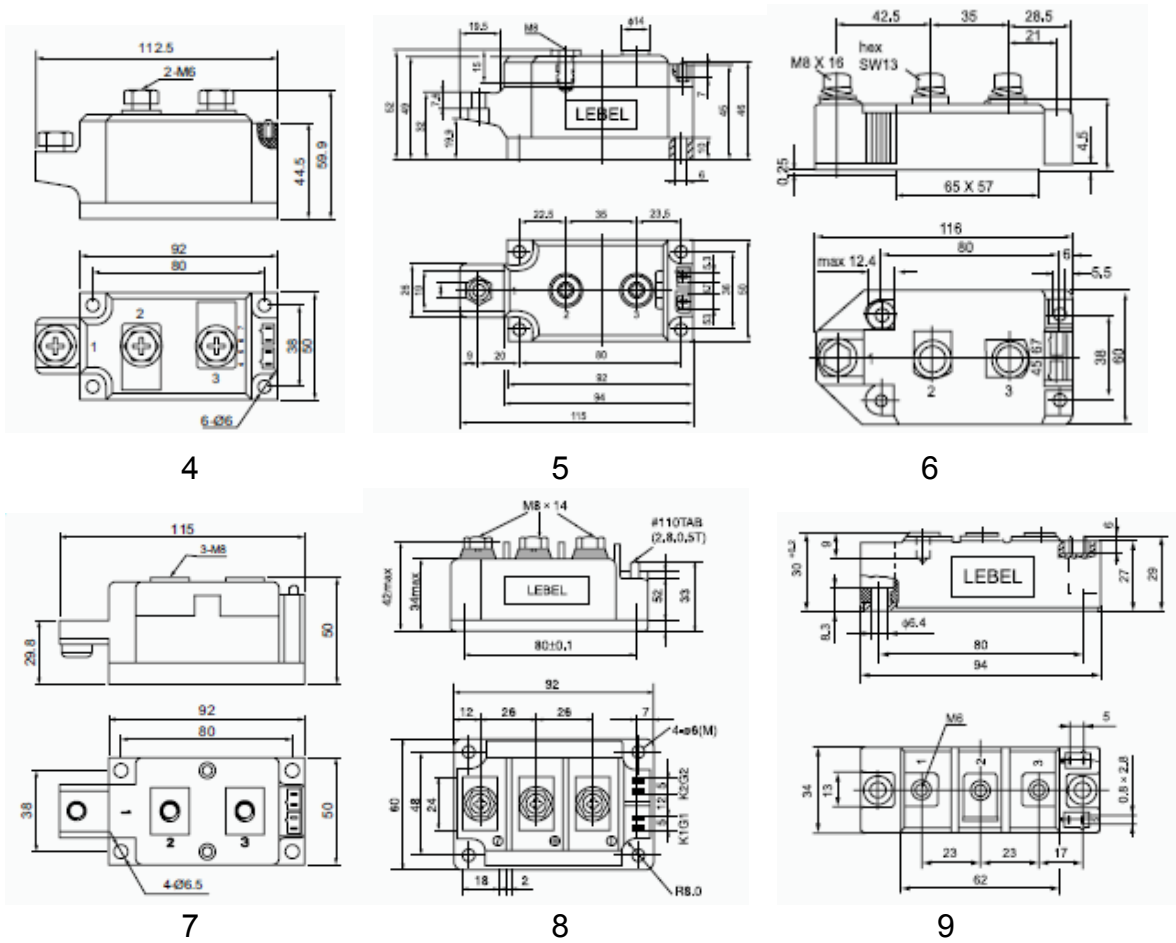


Fig.10

Outline:



Outline:



Circuit Drawing:

